Application No. 10/632,552 Attorney Docket: CPAC 1017-5 D3

## ELECTRONICALLY FILED ON 25 August 2006

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Marcos Karnezos

Attorney Docket No.: CPAC 1017-5 D3

Application No.: 10/632,552

Examiner: Chris C. Chu

Filed: 02 August 2003

Group: 2815

Title: Semiconductor Multi-Package Module Having Package Stacked Over Die-Up Flip Chip Ball Grid Array Package And Having Wire Bond

Confirmation No.: 2572

Interconnect Between Stacked Packages

Customer No. 22470

### INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

It is requested that the information identified in this statement be considered by the Examiner and made of record in the above-identified application. This statement is not intended to represent that a search has been made or that the information cited in the statement is, or is considered to be, material to patentability as defined in 37 C.F.R. 1.56.

Enclosed with this statement is a Form PTO/SB/08A. The Examiner is requested to initial the form and return it to the undersigned in accordance with M.P.E.P. 609.

Also enclosed with this statement is a copy of each cited document as required by 37 C.F.R. 1.98. However, since this application was filed after June 30, 2003, copies of U. S. Patents and U. S. Patent Application Publications are not enclosed. (See O. G. Notice of August 5, 2003.)

This statement should be considered under 37 C.F.R. 1.97(c) because it is being filed before the mailing date of a FINAL office action, a Notice of Allowance, or an action that otherwise closes prosecution in the subject application, whichever occurs first, AND it is accompanied by the \$180 fee set forth in 37 C.F.R. 1.17(p).

Application No. 10/632,552 Attorney Docket: <u>CPAC 1017-5 D3</u>

Fee Authorization. The Commissioner is hereby authorized to charge any additional fees or credit any overpayment associated with this communication to Deposit Account No. 50-0869 (CPAC 1017-5 D3).

Respectfully submitted, Haynes Beffel & Wolfeld LLP

Date: 25 August 2006

Bill Kennedy Havnes Beffel & Wolfeld LLP P.O. Box 366 Half Moon Bay, CA 94019 Ph. (650) 712-0340 Fax (650) 712-0263 bkennedy@hmbay.com BK:pfh

# INFORMATION DISCLOSURE STATEMENT BY APPLICANT

Substitute for form PTO-1449

Sheet 1 of 1

2003
rnezos
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### U.S. PATENT DOCUMENTS

Examiner's Initials	N	Patent No. lumber-Kind Code	Pub. Date MM-DD- YYYY	Name	Pages, Cols, Lines of Relevant Passages or Figures
	US	5,229,960	07-20-1993	De Givry	
	US	5,898,219	04-27-1999	Barrow	
	US	5,899,705	05-04-1999	Akram	
	US	6,118,176	09-12-2000	Tao et al.	
	US	6,133,626	10-17-2000	Hawke et al.	
	US	6,492,726	12-10-2002	Quek et al.	
	US	6,552,423	04-22-2003	Song et al.	
	US	6,706,557	03-16-2004	Koopmans	
	US	6,794,749	09-21-2004	Akram	
	US	6,828,665	12-07-2004	Pu et al.	
	US	6,882,057	04-19-2005	Hsu	
	US	6,900,528	05-31-2006	Mess et al.	
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	US	2003/0113952	06-19-2003	Sambasivam et al.	
	US	2003/0153134	08-14-2003	Kawata et al.	
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#### FOREIGN PATENT DOCUMENTS

Examiner's Initials		Patent No. Number-Kind Code	Pub. Date MM-DD-YYYY	Name	Pages, Cols, Lines of Relevant Material	Т
	B1					
	B2					
	В3					
	В3					
	B4					

Examiner	Date
Signature	Considered